

P2002,0637

NOV 12 2004

U.S. PATENT &amp; TRADEMARK OFFICE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Werner Plass et al. Confirmation No. 9553  
 Applic. No. : 10/631,384  
 Filed : July 31, 2003  
 Title : Surface Emitting Semiconductor Laser Chip and Method for  
 Producing the Chip  
 Examiner : Ahmed N. Sefer Group Art Unit : 2826  
 Docket No. : P2002,0637  
 Customer No. : 24131

DECLARATION UNDER 37 C.F.R. § 1.131

The undersigned, Werner Plass, Christian Jung, Tony Albrecht, Udo Straller,  
 Inventors of this invention, hereby declare that:

The Invention of the above-identified application was conceived and "reduced to  
 practice" at least as early as February 12, 2002.

The undersigned, Werner Plass, Christian Jung, Tony Albrecht, Udo Straller,  
 developed Surface Emitting Semiconductor Laser Chip and Method for Producing  
 the Chip according to the Invention and wrote the Invention Disclosure  
 (Erfindungsmeldung).

Enclosed, as corroborating evidence, is the Invention Disclosure, which is a pre-  
 printed form signed by the undersigned. The Invention Disclosure was executed by  
 the undersigned on November 2, 2001 (see signatures on the bottoms of page 4).  
 The Invention Disclosure was given to Mr. Luft, who is the Inventors' superior, on  
 November 7, 2001. On the right side in the upper half of the first page there is a box  
 that indicates when the Invention Disclosure was received by the Inventors' superior.  
 This box is labeled "Eingang am:" (Received on) and the date "7.11.2001" is  
 handwritten in this box. As is customary in Europe, the order of the handwritten date  
 is day/month/year.

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In the lower half of the first page of the Invention Disclosure Mr. Luft signed and dated the first page of the Invention Disclosure in order to confirm the receipt of the Invention Disclosure on November 7, 2001.

The Invention Disclosure was shortly thereafter further submitted to the corporate patent department of Siemens Aktiengesellschaft and it was received, as best understood, on November 14, 2001 (see the lower right corner of page 1).

The undersigned hereby declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Werner Plass

Werner Plass

08.11.2004

Date

Christian Jung

Date

T. Albrecht

Tony Albrecht

08.11.2004

Date

Udo Streller

Date

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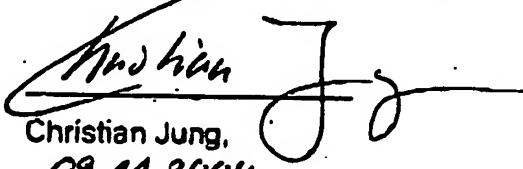
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Werner Plass

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Date



Christian Jung,  
09.11.2004

Date

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Tony Albrecht

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Date

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Udo Streller

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Date

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Werner Plass

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Tony Albrecht

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Christian Jung,

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Udo Streller

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